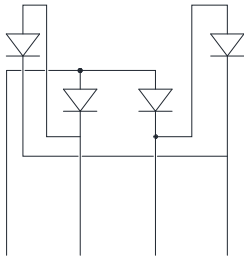
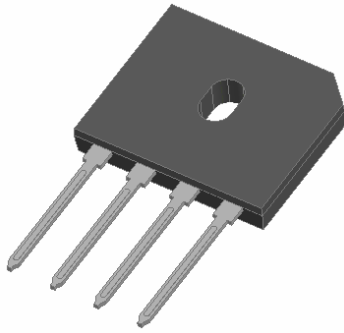




## High Efficient Bridge Rectifiers



### Features

- UL recognition, file #E230084
- Glass passivated chip junction
- Ideal for printed circuit boards
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

### Typical Applications

General purpose use in AC/DC bridge full wave rectification for monitor, TV, printer, power supply, switching mode power supply, adapter, audio equipment, and home appliances applications.

### Mechanical Data

- Package:** GBU
- Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant
- Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- Polarity:** As marked on body

### Maximum Ratings (T<sub>a</sub>=25 °C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	HGBU1004	
Device marking code			HGBU1004	
Maximum Repetitive Peak Reverse Voltage	VRRM	V	400	
Maximum RMS Voltage	VRMS	V	280	
Maximum DC blocking Voltage	VDC	V	400	
Average rectified output current @60Hz half sine wave, R-load	With heatsink T <sub>c</sub> =100 -	I <sub>O</sub>	A	10.0
	Without heatsink T <sub>a</sub> =25 -			3.2
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave, 1 cycle, T <sub>j</sub> =25 -	I <sub>FSM</sub>	A	150	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, T <sub>j</sub> =25 -			300	
Current squared time @1ms t 8.3ms T <sub>j</sub> =25 - , Rating of per diode	I <sup>2</sup> t	A <sup>2</sup> S	93	
Storage temperature	T <sub>stg</sub>	-	-55 ~ +150	
Junction temperature	T <sub>j</sub>	-	-55 ~ +150	
Dielectric strength @ Terminals to case, AC 1 minute	V <sub>dis</sub>	KV	2.5	
Mounting torque @Recommend torque 0.5kg cm	Tor	kg cm	8	

### Electrical Characteristics (T<sub>a</sub>=25 °C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	HGBU1004
Maximum reverse recovery time	T <sub>RR</sub>	ns	I <sub>F</sub> =0.5A, I <sub>R</sub> =1.0A, I <sub>RR</sub> =0.25A	50



# HGBU1004

## Thermal Characteristics $\dot{A}T_a=25$ Unless otherwise specified $\dot{A}$

PARAMETER		SYMBOL	UNIT	HGBU1004
Thermal Resistance	Between junction and ambient, Without heatsink	R J-A	- /W	20
	Between junction and case, With heatsink	R J-C		2

Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

## Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
HGBU1004	B1	Approximate 3.96	20	1000	2000	TUBE

## Characteristics (Typical)

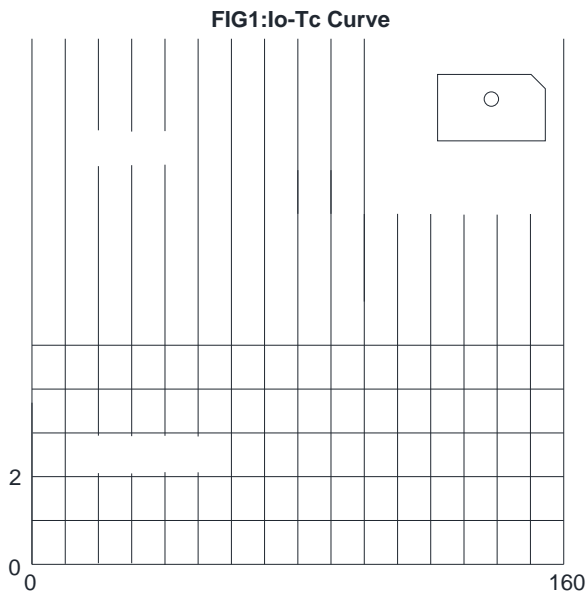
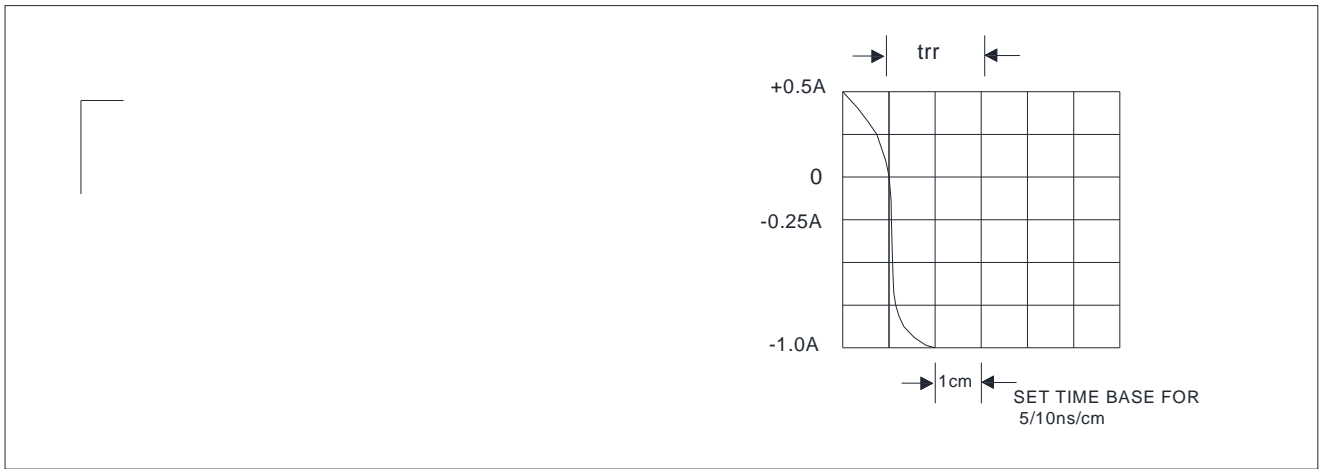


FIG.5: Diagram of circuit and Testing wave form of reverse recovery time



## Outline Dimensions

GBU		
Dim	Min	Max
A	21.80	22.30
B	18.30	18.80
C	17.50	18.00
D	3.50	4.10
E	7.40	7.90
F	1.65	2.16
G	1.91	2.54
H	2.06	2.54
I	1.02	1.27
J	4.83	5.33
K	3.30	3.56
L	2.40	2.66
M	0.46	0.56



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